

- t. 0,2,3,5,7 or 8 I/O slot wall mount & 19" frames
- u. Expansion frames allow up to 110 I/O modules in a single RTU.
- v. Redundant CPU and power supply
- w. Single and double density I/O modules
- x. Mixed analog input and output modules
- y. Hot Swap I/O replacement
- z. Wide operating temperature range -40 to +70 °C
- aa. NEMA 4 / IP66 Housing, 40 x 40 cm and 50 x 50 cm
- bb. Two-way/trunking/ digital radio models
- cc. AC and DC controlled power supply
- dd. 6.5 or 10 Ah Backup battery, smart battery charger
- ee. GPS and NTP for time synchronization
- ff. System building tool for configuration and programming
- gg. Remote firmware and program download
- hh. Compatible with MOSCAD family of RTUs
- ii. Multiple Protocol Support: Modbus, DNP 3.0, DF1, IEC 60870-5-101
- jj. All I/O signals shall be buffered,
- kk. The CPU shall contain a function block for accumulated Flow, Pump Running Hours, Pump Number of Starts
- ll. The CPU shall contain a function block for self-battery test in daily condition
- mm. Digital I/O signals shall have LED indicator
- nn. The RTU program shall be able to be uploaded from RTU to Laptop in full editable condition

#### **1.3.23.2 RTU Hardware**

- A. RTU will be the main device used to control loops in each RTU process area. Each RTU shall be able to receive analogue and digital inputs from the field, perform input signal processing and alarm checking, perform algorithms control, and output to valves and other actuators.